

Customer Information Notification

Issue Date: 25-May-2016 Effective Date: 25-Jun-2016

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

2016050011



Management Summary

Data sheet update for PESD1LVDS with respect to ambient temperature.

Change Category

| [] Wafer Fab | [] Assembly | [] Product Marking | [] Test | [] Design |
|--------------|-------------|-----------------------------|-----------|---------------------------|
| Process | Process | | Process | |
| [] Wafer Fab | [] Assembly | [] Mechanical Specification | []Test | [] Errata |
| Materials | Materials | | Equipment | |
| [] Wafer Fab | [] Assembly | [] | [] Test | [X] Electrical spec./Test |
| Location | Location | Packing/Shipping/Labeling | Location | coverage |

Data sheet update of PESD1LVDS

Information Notification

The data sheet of ESD protection type PESD1LVDS will be updated. The allowed maximum temperature for T_amb will be increased from +85°C to +125°C. There is no change in electrical behavior. The product remains unchanged.

Why do we issue this Information Notification

Update of data sheet

Identification of Affected Products

Product identification does not change

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name GA Customer Support

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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